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FQD6N40C

N-Channel QFET[®] MOSFET 400 V, 4.5 A, 1.0 Ω

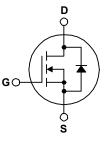
Features

- + 4.5 A, 400 V, $R_{DS(on)}$ = 1.0 Ω (Max.) @V_{GS} = 10 V, I_D = 2.25 A
- Low Gate Charge (Typ. 16 nC)
- Low Crss (Typ. 15 pF)
- 100% Avalanche Tested

Description

This N-Channel enhancement mode power MOSFET is produced using ON Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

| Symbol | Parameter | | FQD6N40CTM | Unit |
|-----------------------------------|---|----------|-------------|------|
| V _{DSS} | Drain-Source Voltage | 400 | V | |
| I _D | Drain Current - Continuous (T _C = 25°C) | | 4.5 | A |
| | - Continuous (T _C = 100°C) | | 2.7 | А |
| I _{DM} | Drain Current - Pulsed | (Note 1) | 18 | A |
| V _{GSS} | Gate-Source Voltage | | ± 30 | V |
| E _{AS} | Single Pulsed Avalanche Energy (Note 2) | | 270 | mJ |
| I _{AR} | Avalanche Current | | 4.5 | A |
| E _{AR} | Repetitive Avalanche Energy (No | | 4.8 | mJ |
| dv/dt | Peak Diode Recovery dv/dt | (Note 3) | 4.5 | V/ns |
| | Power Dissipation (T _A = 25°C)* | | 2.5 | W |
| PD | Power Dissipation (T _C = 25°C) | | 48 | W |
| | - Derate above 25°C | | 0.38 | W/°C |
| T _J , T _{STG} | Operating and Storage Temperature Range | | -55 to +150 | °C |
| TL | Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds | | 300 | °C |

Thermal Characteristics

| Symbol | Parameter | FQD6N40CTM | Unit |
|-----------------|--|------------|------|
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case, Max. | 2.6 | |
| P | Thermal Resistance, Junction-to-Ambient (minimum pad of 2 oz copper), Max. | 110 | °C/W |
| $R_{	heta JA}$ | Thermal Resistance, Junction-to-Ambient (* 1 in ² pad of 2 oz copper), Max. | 50 | |

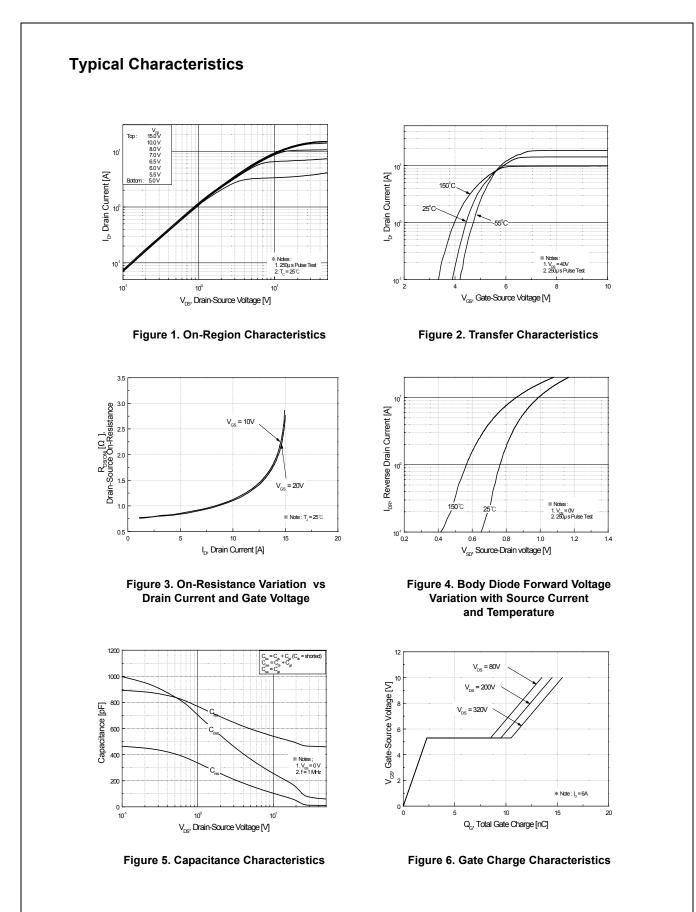
| Device Marking FQD6N40C | | Device | Package | Reel Size | Таре | Width | Quantity | | |
|--|-------------------------------------|---|---|-------------|-------|-------|------------|------|--|
| | | FQD6N40CTM | D-PAK | 330 mm | 16 mm | | 2500 units | | |
| Electrical Characteristics $T_{C} = 25^{\circ}C$ unless otherwise noted. | | | | | | | | | |
| Symbol | nbol Parameter | | Test C | Min | Тур | Max | Unit | | |
| Off Cha | racteristi | cs | | | | | | | |
| BV _{DSS} | Drain-Sour | ce Breakdown Voltage | V _{GS} = 0 V, I _D = 2 | 250 μΑ | 400 | | | V | |
| ΔBV _{DSS} / ΔT _J | Breakdown Coefficient | Voltage Temperature | I_D = 250 µA, Referenced to 25°C | | | 0.54 | | V/°C | |
| | | V _{DS} = 400 V, V _G | | | 1 | μA | | | |
| DSS | DSS Zero Gate Voltage Drain Current | | V _{DS} = 320 V, T _C | | | 10 | μA | | |
| I _{GSSF} | Gate-Body | Leakage Current, Forward | V _{GS} = 30 V, V _{DS} | = 0 V | | | 100 | nA | |
| I _{GSSR} | Gate-Body | Leakage Current, Reverse | V_{GS} = -30 V, V_{DS} = 0 V | | | | -100 | nA | |
| On Cha | racteristi | cs | | | _ | _ | | _ | |
| V _{GS(th)} | Gate Thres | hold Voltage | $V_{DS} = V_{GS}, I_D = 1$ | 250 μΑ | 2.0 | | 4.0 | V | |
| R _{DS(on)} | Static Drair On-Resista | | V _{GS} = 10 V, I _D = | 2.25A | | 0.83 | 1 | Ω | |
| 9 _{FS} | Forward Tr | ansconductance | V _{DS} = 40 V, I _D = | 2.25A | | 4.7 | | S | |
| Dynami | ic Charac | teristics | | | | | | | |
| C _{iss} | Input Capa | | V _{DS} = 25 V, V _{GS} | = 0 V | | 480 | 625 | pF | |
| C _{oss} | Output Cap | pacitance | f = 1.0 MHz | U 1, | | 80 | 105 | pF | |
| C _{rss} | Reverse Tr | ansfer Capacitance | | | | 15 | 20 | pF | |
| Switchi | ng Chara | cteristics | | | | | | | |
| t _{d(on)} | Turn-On De | elay Time | V _{DD} = 200 V, I _D : | = 64 | | 13 | 35 | ns | |
| t _r | Turn-On Ri | se Time | $R_{G} = 25 \Omega$ | · · · · | | 65 | 140 | ns | |
| t _{d(off)} | Turn-Off De | elay Time | | F | | 21 | 55 | ns | |
| t _f | Turn-Off Fa | III Time | | (Note 4) | | 38 | 85 | ns | |
| Qg | Total Gate | Charge | V _{DS} = 320 V, I _D = | = 6A, | | 16 | 20 | nC | |
| Q _{gs} | Gate-Source | ce Charge | V _{GS} = 10 V | Ē | | 2.3 | | nC | |
| Q _{gd} | Gate-Drain | Charge | | (Note 4) | | 8.2 | | nC | |
| | ource Dic | ode Characteristics ar | nd Maximum F | Ratings | _ | | | _ | |
| I _S | | Continuous Drain-Source Dic | | - | | | 4.5 | Α | |
| I _{SM} | | Pulsed Drain-Source Diode F | | | | | 18 | Α | |
| V _{SD} | Drain-Sour | ce Diode Forward Voltage | $V_{GS} = 0 V, I_{S} = 4$ | 4.5 A | | | 1.4 | V | |
| t _{rr} | | ecovery Time | $V_{GS} = 0 V, I_{S} = 0$ | | | 230 | | ns | |
| Q _{rr} | Devere D | ecovery Charge | dI _F / dt = 100 A/L | | | 1.7 | | μC | |

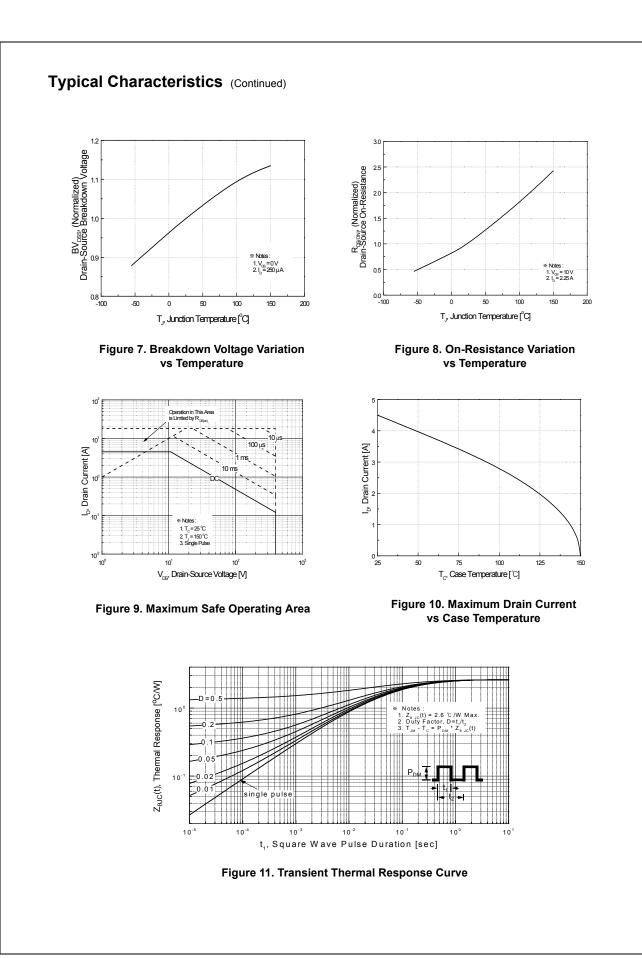
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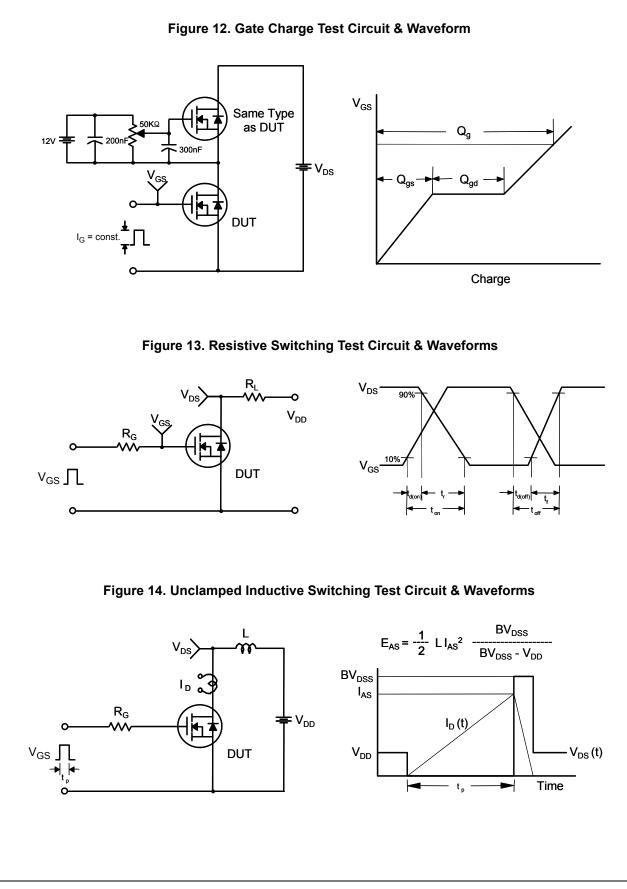
2. L = 13.7 mH, I_{AS} = 6 A, V_{DD} = 50V, R_G = 25 $\Omega,$ starting T_J = 25°C.

3. I_{SD} \leq \, 6A, di/dt \leq 200A/µs, V_{DD} \leq BV_{DSS,} starting ~ T_J = 25°C.

4. Essentially independent of operating temperature.







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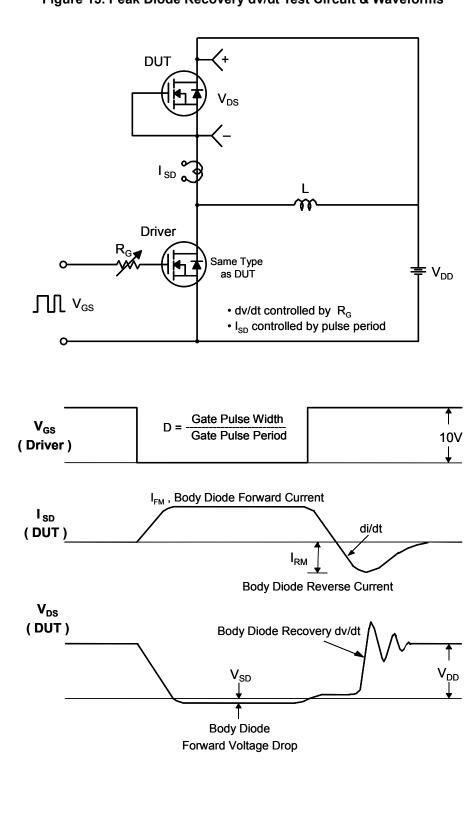


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

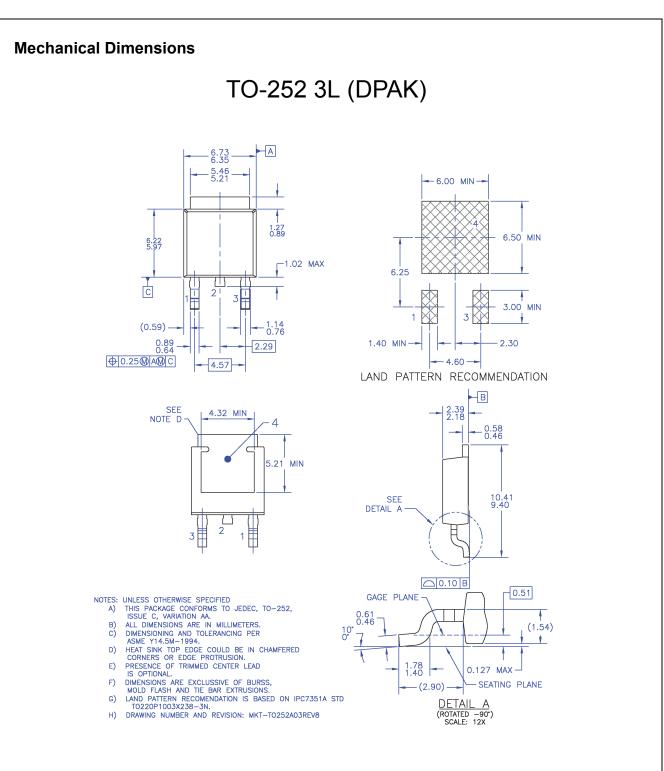


Figure 16. TO252 (D-PAK), Molded, 3 Lead, Option AA&AB

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